## COMPOUND FIELD EFFECT POWER TRANSISTOR $\mu$ PA1500B

## N-CHANNEL POWER MOS FET ARRAY <br> SWITCHING USE

## DESCRIPTION

The $\mu$ PA1500B is N-channel Power MOS FET Array that built in 4 circuits and surge absorber designed for solenoid, motor and lamp driver.

## FEATURES

- 4 V driving is possible
- Large Current and Low On-state Resistance $\operatorname{ld}(\mathrm{DC})= \pm 3 \mathrm{~A}$
$\operatorname{Rds}($ on $) 1 \leq 0.18 \Omega \mathrm{MAX}$. $(\mathrm{VGs}=10 \mathrm{~V}, \mathrm{Id}=2 \mathrm{~A})$
$\operatorname{RDS}($ on $) 2 \leq 0.24 \Omega \mathrm{MAX} .(\mathrm{VGS}=4 \mathrm{~V}, \mathrm{ID}=2 \mathrm{~A})$
- Low Input Capacitance Ciss $=200$ pF TYP.
- Surge Absorber, built in


## ORDERING INFORMATION

| Type Number | Package |
| :--- | :---: |
| $\mu$ PA1500BH | 12 Pin SIP |


| ABSOLUTE MAXIMUM R | RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ) |  |  |
| :---: | :---: | :---: | :---: |
| Drain to Source Voltage | Voss Note 1 | 60 | V |
| Gate to Source Voltage | Vass Note 2 | $\pm 20$ | V |
| Drain Current (DC) | $\mathrm{ld}(\mathrm{DC})$ | $\pm 3.0$ | A/unit |
| Drain Current (pulse) | ID(pulse) Note 3 | $\pm 12$ | A/unit |
| Repetitive peak Reverse Voltage | Vrrm Note 4 | 65 | V |
| Diode Forward Current | $\mathrm{IF}_{(\mathrm{av})}$ Note 4 | 3.0 | A/unit |
| Total Power Dissipation | $\mathrm{P}_{\mathrm{T} 1}$ Note 5 | 28 | W |
| Total Power Dissipation | $\mathrm{P}_{\text {T2 } 2}$ Note 6 | 4.0 | W |
| Channel Temperature | Tch | 150 | C |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | -55 to 150 | C |
| Single Avalanche Current | IAS $^{\text {Note }} 7$ | 3.0 | A |
| Single Avalanche Energy | Eas Note 7 | 0.9 | mJ |
| Notes 1. $\mathrm{V}_{\mathrm{GS}}=0$ |  |  |  |
| 2. $\mathrm{V} \mathrm{DS}=0$ |  |  |  |
| 3. $\mathrm{PW} \leq 10 \mu \mathrm{~s}$, Duty Cycle $\leq 1 \%$ |  |  |  |
| 4. Rating of Surge Absorber |  |  |  |
| 5. 4 Circuits, $\mathrm{Tc}=25^{\circ} \mathrm{C}$ |  |  |  |
| 6. 4 Circuits, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |
| 7. Starting $\mathrm{T} C \mathrm{H}=25^{\circ} \mathrm{C}, \mathrm{V} \mathrm{dD}=30 \mathrm{~V}, \mathrm{VGS}=20 \mathrm{~V} \rightarrow 0$, |  |  |  |

 $R G=25 \Omega, L=100 \mu \mathrm{H}$

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain Leakage Current | Idss | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{VGS}=0$ |  |  | 10 | $\mu \mathrm{A}$ |
| Gate Leakage Current | Iass | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| Gate Cutoff Voltage | VGS(off) | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{ld}=1.0 \mathrm{~mA}$ | 1.0 |  | 2.0 | V |
| Forward Transfer Admittance | \| $\mathrm{Yfs}_{\text {\| }}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ID}=2.0 \mathrm{~A}$ | 2.0 |  |  | S |
| Drain to Source On-State | Ros(on) 1 | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ld}=2.0 \mathrm{~A}$ |  | 0.10 | 0.18 | $\Omega$ |
| Resistance | RDS(on)2 | $\mathrm{V}_{\mathrm{Gs}}=4.0 \mathrm{~V}, \mathrm{ld}=2.0 \mathrm{~A}$ |  | 0.14 | 0.24 | $\Omega$ |
| Input Capacitance | Ciss | $V_{D S}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1.0 \mathrm{MHz}$ |  | 200 |  | pF |
| Output Capacitance | Coss |  |  | 150 |  | pF |
| Reverse Transfer Capacitance | Crss |  |  | 55 |  | pF |
| Turn-on Delay Time | tdon) | $\begin{aligned} & \mathrm{ID}=2.0 \mathrm{~A}, \mathrm{~V} \text { GS }=10 \mathrm{~V}, \mathrm{~V} D \mathrm{O} \fallingdotseq 30 \mathrm{~V}, \\ & \mathrm{RL}=15 \Omega \end{aligned}$ |  | 20 |  | ns |
| Rise Time | tr |  |  | 100 |  | ns |
| Turn-off Delay Time | ta(off) |  |  | 735 |  | ns |
| Fall Time | tf |  |  | 350 |  | ns |
| Total Gate Charge | QG | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{ld}=3.0 \mathrm{~A}, \mathrm{VdD}=48 \mathrm{~V}$ |  | 13 |  | nC |
| Gate to Source Charge | Qas |  |  | 2 |  | nC |
| Gate to Drain Charge | Qgi |  |  | 4.7 |  | nC |
| Body Diode Forward Voltage | $\mathrm{V}_{\text {F(S-D) }}$ | $\mathrm{IF}_{\mathrm{F}}=3 \mathrm{~A}, \mathrm{VGS}=0$ |  | 1.0 |  | V |

## SURGE ABSORBER (Diode, builtin) 1 Unit

| Repetitive peak Reverse Current | $I_{R R M}$ | $\mathrm{~V}_{\mathrm{R}}=65 \mathrm{~V}$ |  |  | 10 |
| :--- | :--- | :--- | :--- | :--- | :---: |
| Diode Forward Voltage | $\mathrm{V}_{\mathrm{F}}$ | $\mathrm{I}_{\mathrm{F}}=3.0 \mathrm{~A}$ |  |  |  |

## Test Circuit 1 Avalanche Capability




$$
\begin{array}{l|l|l}
V_{G S} & & \\
0 & t & \\
& \\
& \\
&
\end{array}
$$

$$
\mathrm{t}=1 \mu \mathrm{~s}
$$

$$
\text { Duty Cycle } \leq 1 \%
$$



Test Circuit 3 Gate Charge


2

## TYPICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )





TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



DRAIN CURRENT vs.


Vos - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH









## REFERENCE

| Document Name | Document No. |
| :--- | :---: |
| NEC semiconductor device reliability/quality control system | TEI-1202 |
| Quality grade on NEC semiconductor devices | IEI-1209 |
| Semiconductor device mounting technology manual | IEI-1207 |
| Semiconductor device package manual | IEI-1213 |
| Guide to quality assurance for semiconductor devices | MEI-1202 |
| Semiconductor selection guide | MF-1134 |
| Power MOS FET features and application switching power supply | TEA-1034 |
| Application circuits using Power MOS FET | TEA-1035 |
| Safe operating area of Power MOS FET | TEA-1037 |

[MEMO]

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.
NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.
While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customer must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.
NEC devices are classified into the following three quality grades:
"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.
The quality grade of NEC devices in "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact NEC Sales Representative in advance.
Anti-radioactive design is not implemented in this product.

